# Very Low Supply Current 3-Pin Microprocessor Reset Monitor

The MAX803/NCP803 is a cost–effective system supervisor circuit designed to monitor  $V_{CC}$  in digital systems and provide a reset signal to the host processor when necessary. No external components are required.

The reset output is driven active within 10  $\mu$ sec of V<sub>CC</sub> falling through the reset voltage threshold. Reset is maintained active for a timeout period which is trimmed by the factory after V<sub>CC</sub> rises above the reset threshold. The MAX803/NCP803 has an open drain active–low RESET output. Both devices are available in SOT–23 and SC–70 packages.

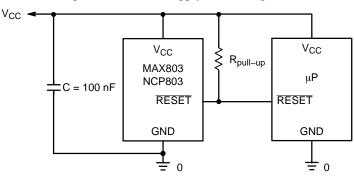
The MAX803/NCP803 is optimized to reject fast transient glitches on the V<sub>CC</sub> line. Low supply current of 0.5  $\mu$ A (V<sub>CC</sub> = 3.2 V) make these devices suitable for battery powered applications.

#### Features

- Precision V<sub>CC</sub> Monitor for 1.5 V, 2.5 V, 3.0 V, 3.3 V, and 5.0 V Supplies
- Precision Monitoring Voltages from 1.2 V to 4.9 V Available in 100 mV Steps
- Four Guaranteed Minimum Power–On Reset Pulse Width Available (1 ms, 20 ms, 100 ms, and 140 ms)
- **RESET** Output Guaranteed to  $V_{CC} = 1.0 \text{ V}$
- Low Supply Current
- V<sub>CC</sub> Transient Immunity
- No External Components
- Wide Operating Temperature: -40°C to 105°C
- These Devices are Pb-Free and are RoHS Compliant

#### **Typical Applications**

- Computers
- Embedded Systems
- Battery Powered Equipment
- Critical Microprocessor Power Supply Monitoring

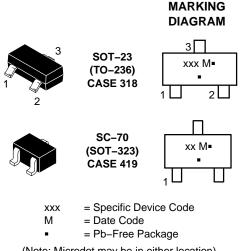


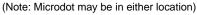


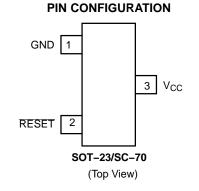


## **ON Semiconductor®**

www.onsemi.com





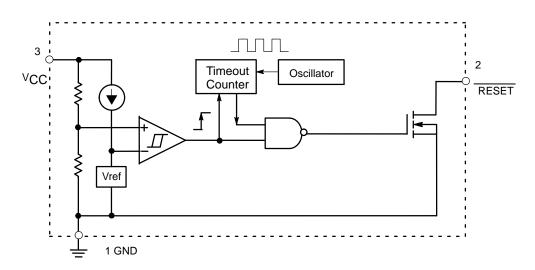


#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

#### DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 8 of this data sheet.





#### **PIN DESCRIPTION**

Pin No.	Symbol	Description
1	GND	Ground
2	RESET	RESET output remains low while $V_{CC}$ is below the reset voltage threshold, and for a reset timeout period after $V_{CC}$ rises above reset threshold.
3	V <sub>CC</sub>	Supply Voltage: C = 100 nF is recommended as a bypass capacitor between $V_{CC}$ and GND.

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Power Supply Voltage (V <sub>CC</sub> to GND)	V <sub>CC</sub>	-0.3 to 6.0	V
RESET Output Voltage (CMOS)		–0.3 to (V <sub>CC</sub> + 0.3)	V
Input Current, V <sub>CC</sub>		20	mA
Output Current, RESET		20	mA
dV/dt (V <sub>CC</sub> )		100	V/µsec
Thermal Resistance, Junction-to-Air (Note 1)       SOT-23         SC-70       SC-70	007	301 314	°C/W
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Lead Temperature (Soldering, 10 Seconds)	T <sub>sol</sub>	+260	°C
ESD Protection Human Body Model (HBM): Following Specification JESD22–A114 Machine Model (MM): Following Specification JESD22–A115		2000 200	V
Latchup Current Maximum Rating: Following Specification JESD78 Class II Positive Negative		200 200	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. This based on a 35x35x1.6mm FR4 PCB with 10mm<sup>2</sup> of 1 oz copper traces under natural convention conditions and a single component

characterization.

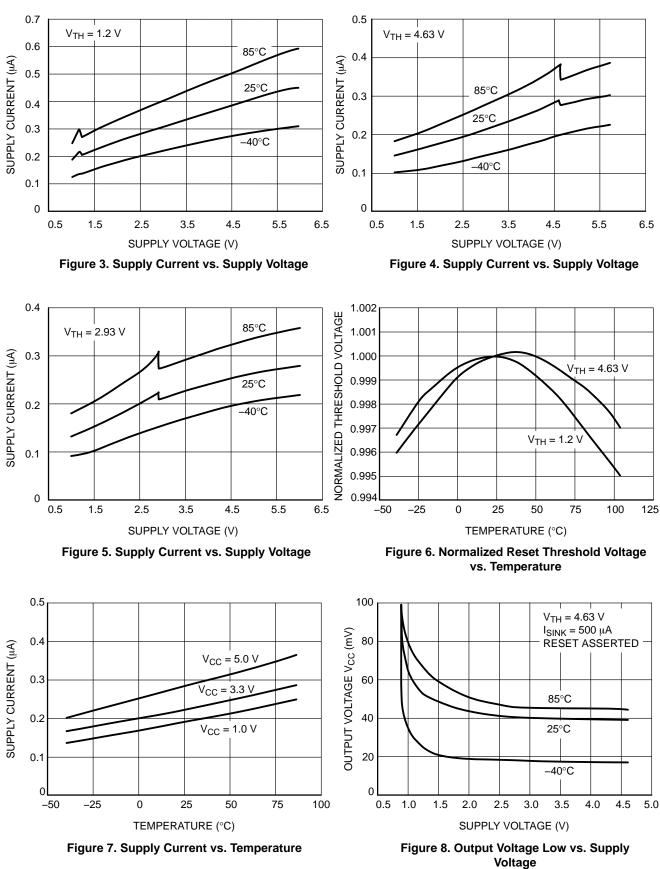
2. The maximum package power dissipation limit must not be exceeded.  $P_{D} = \frac{T_{J(max)} - T_{A}}{T_{J(max)}}$ 

$$\frac{\text{Hax}}{\text{R}_{\theta}\text{JA}} \qquad \text{with } \text{T}_{\text{J}(\text{max})} = 150^{\circ}\text{C}$$

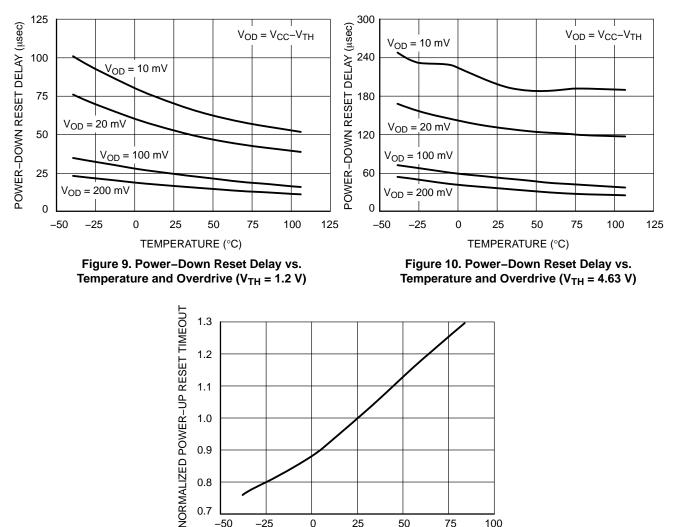
Characteristic	Symbol	Min	Тур	Max	Unit
V <sub>CC</sub> Range					V
$T_A = 0^{\circ}C$ to $+70^{\circ}C$		1.0	-	5.5	
$T_A = -40^{\circ}C \text{ to } +105^{\circ}C \text{ (Note 4)}$		1.2	-	5.5	
Supply Current	I <sub>CC</sub>		1		μΑ
V <sub>CC</sub> = 3.3 V					
$T_A = -40^{\circ}C$ to $+85^{\circ}C$		-	0.5	1.2	
$T_A = 85^{\circ}C \text{ to } +105^{\circ}C \text{ (Note 5)}$		-	-	2.0	
$V_{CC} = 5.5 V$					
$T_A = -40^{\circ}C$ to $+85^{\circ}C$		-	0.8	1.8	
$T_A = 85^{\circ}C \text{ to } +105^{\circ}C \text{ (Note 5)}$		-	-	2.5	
Reset Threshold (V <sub>in</sub> Decreasing) (Note 6)	V <sub>TH</sub>				V
MAX803SQ463/NCP803SN463					
$T_A = +25^{\circ}C$		4.56	4.63	4.70	
$T_A = -40^{\circ}C$ to $+85^{\circ}C$		4.51	-	4.75	
$T_A = +85^{\circ}C \text{ to } +105^{\circ}C \text{ (Note 5)}$		4.40	-	4.88	
MAX803SQ438/NCP803SN438					
$T_A = +25^{\circ}C$		4.31	4.38	4.45	
$T_A = -40^{\circ}C$ to $+85^{\circ}C$		4.27		4.49	
$T_A = +85^{\circ}C$ to $+105^{\circ}C$ (Note 5)		4.16		4.60	
NCP803SN400					
$T_A = +25^{\circ}C$		3.94	4.00	4.06	
$T_A = -40^{\circ}C$ to $+85^{\circ}C$		3.90		4.10	
$T_A = +85^{\circ}C$ to $+105^{\circ}C$ (Note 5)		3.80		4.20	
MAX803SQ308/NCP803SN308					
$T_A = +25^{\circ}C$		3.04	3.08	3.11	
$T_A = -40^\circ$ C to +85°C		3.00	_	3.15	
$T_{A} = +85^{\circ}C \text{ to } +105^{\circ}C \text{ (Note 5)}$		2.92	_	3.23	
MAX803SQ293/NCP803SN293					
$T_A = +25^{\circ}C$		2.89	2.93	2.96	
$T_{A} = -40^{\circ}$ C to +85°C		2.85		3.00	
$T_A = +85^{\circ}C$ to $+105^{\circ}C$ (Note 5)		2.78	_	3.08	
NCP803SN263					
$T_{A} = +25^{\circ}C$		2.59	2.63	2.66	
$T_{A} = -40^{\circ}$ C to +85°C		2.55	2.00	2.70	
$T_A = +85^{\circ}C$ to +105°C (Note 5)		2.50	_	2.76	
NCP803SN232		2.00		2.70	
$T_{A} = +25^{\circ}C$		2.29	2.32	2.35	
$T_A = +23$ C $T_A = -40^{\circ}$ C to +85°C		2.29	2.32	2.33	
$T_A = -40$ C to +05 C $T_A = +85^{\circ}$ C to +105°C (Note 5)		2.20	_	2.38	
		2.20	_	2.40	
NCP803SN160		1 50	1.60	1.60	
$T_{A} = +25^{\circ}C$		1.58	1.60	1.62	
$T_A = -40^{\circ}C$ to $+85^{\circ}C$ Tr = $+85^{\circ}C$ to $+105^{\circ}C$ (Noto 5)		1.56 1.52	_	1.64	
$T_A = +85^{\circ}C \text{ to } +105^{\circ}C \text{ (Note 5)}$		1.52	-	1.68	
MAX803SN120, MAX803SQ120		1 1 0	1 20	1 00	
$T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C		1.18 1.17	1.20	1.22 1.23	
$T_A = -40$ C to +85 C $T_A = +85^{\circ}$ C to +105°C (Note 5)		1.17	_	1.23	
Detector Voltage Threshold Temperature Coefficient			30	-	ppm/ <sup>c</sup>
		_	10	_	
$V_{CC}$ to Reset Delay $V_{CC} = V_{TH}$ to ( $V_{TH} - 100 \text{ mV}$ ) Reset Active TimeOut Period (Note 6)		-	10		μsec
MAX803SN(Q)293D1	t <sub>RP</sub>	1.0	_	3.3	msee
MAX803SN(Q)293D2/MAX803SN(Q)308D2		20	_	5.5 66	
MAX803SN(Q)293D3		100	_	330	
MAX803SN(Q)293		140	-	460	
RESET Output Voltage Low	V <sub>OL</sub>	_	- 1	0.3	V
$V_{CC} = V_{TH} - 0.2 V$	- OL				
$1.6 \text{ V} \le \text{V}_{\text{TH}} \le 2.0 \text{ V}, \text{ I}_{\text{SINK}} = 0.5 \text{ mA}$					
$2.1 \text{ V} \le \text{V}_{\text{TH}} \le 4.0 \text{ V}, \text{ I}_{\text{SINK}} = 1.2 \text{ mA}$					
$4.1 \text{ V} \le \text{V}_{\text{TH}} \le 4.9 \text{ V}, \text{I}_{\text{SINK}} = 3.2 \text{ mA}$					
RESET Leakage Current V <sub>CC</sub> > V <sub>TH</sub> , RESET De-asserted			L		

**ELECTRICAL CHARACTERISTICS**  $T_A = -40^{\circ}C$  to  $+105^{\circ}C$  unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ . (Note 3)

3. Production testing done at  $T_A = 25^{\circ}$ C, over temperature limits guaranteed by design. 4. For NCV automotive devices, this temperature range is  $T_A = -40^{\circ}$ C to +125°C. 5. For NCV automotive devices, this temperature range is  $T_A = +85^{\circ}$ C to +125°C. 6. Contact your ON Semiconductor sales representative for other threshold voltage and timeout options.



**TYPICAL OPERATING CHARACTERISTICS** 



### **TYPICAL OPERATING CHARACTERISTICS**

25 TEMPERATURE (°C)

50

75

100

0.7 -50

-25

0

Figure 11. Normalized Power–Up Reset vs. Temperature

### **Detail Operation Description**

The MAX803, NCP803 series microprocessor reset supervisory circuits are designed to monitor the power supplies in digital systems and provide a reset signal to the processor without any external components. Figure 2 shows the timing diagram and a typical application below. Initially consider that input voltage  $V_{CC}$  is at a nominal level greater than the voltage detector upper threshold ( $v_{TH}$ ). And the

RESET (RESET) output voltage (Pin 2) will be in the high state for MAX803 and NCP803 devices. If there is an input

power interruption and  $V_{CC}$  becomes significantly deficient, it will fall below the lower detector threshold ( $V_{TH-}$ ). This event causes the RESET output to be in the low state for the MAX803 and NCP803 devices. After completion of the power interruption,  $V_{CC}$  will rise to its nominal level and become greater than the  $V_{TH}$ . This sequence activates the internal oscillator circuitry and digital counter to count. After the count of the timeout period, the reset output will revert back to the original state.

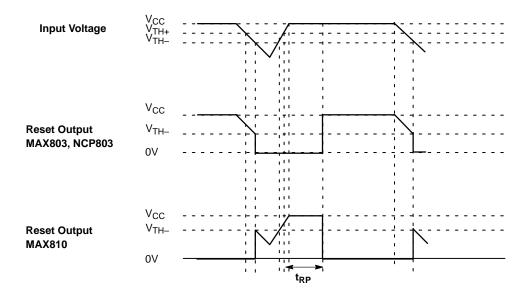
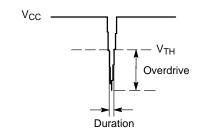


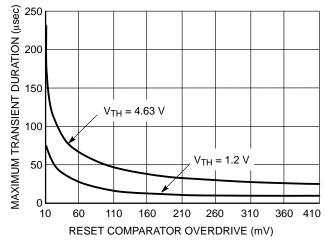
Figure 12. Timing Waveforms

### **APPLICATIONS INFORMATION**

#### V<sub>CC</sub> Transient Rejection

The MAX803/NCP803 series provides accurate  $V_{CC}$  monitoring and reset timing during power–up, power–down, and brownout/sag conditions, and rejects negative–going transients (glitches) on the power supply line. Figure 13 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive which lies under the curve will not generate a reset signal. Combinations above the curve are detected as a brownout or power–down. Typically, transient that goes 100 mV below the reset threshold and lasts 5.0 µs or less will not cause a reset pulse. Transient immunity can be improved by adding a capacitor in close proximity to the V<sub>CC</sub> pin of the MAX803.



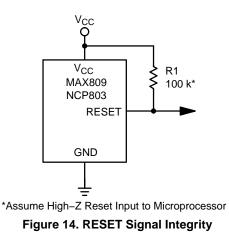




#### **RESET** Signal Integrity During Power–Down

The MAX803/NCP803  $\overline{\text{RESET}}$  output is valid to V<sub>CC</sub> = 1.0 V. Below this voltage the output becomes an "open circuit" and does not sink current. This means CMOS logic inputs to the Microprocessor will be floating at an undetermined voltage. Most digital systems are completely shutdown well above this voltage. However, in situations where  $\overline{\text{RESET}}$  must be maintained valid to V<sub>CC</sub> = 0 V, since

the NCP803/MAX803 has Open–Drain and active–low output, it typically uses a pullup resistor. With this device, RESET will most likely not maintain an active condition, but will drift to a non–active level due to the pullup resistor and the reduced sinking capability of the open–drain device. Therefore, this device is not recommended for applications where the RESET pin is required to be valid down to  $V_{CC} = 0 \text{ V}.$ 



# MAX803 RESET Output Allows Use With Two Power Supplies

In numerous applications the pullup resistor place on the RESET output is connected to the supply voltage monitored by the IC. Nevertheless, a different supply voltage can also power this output and so level-shift from the monitored supply to reset the microprocessor. However, if the NCP803/MAX803's supply goes blew 1 V, the RESET output ability to sink current will decrease and the result is a high state on the pin even though the supply's IC is under the threshold level. This occurs at a V<sub>CC</sub> level that depends on the R<sub>pullup</sub> value and the voltage which is connected.

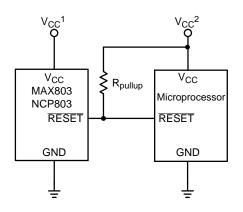


Figure 15. MAX803 RESET Output with Two Supplies

### ORDERING, MARKING AND THRESHOLD INFORMATION

Part Number	Vth** (V)	Time out*** (ms)	Description	Marking	Package	Shipping <sup>†</sup>
NCP803SN160T1G	1.60	140–460		SCQ	SOT23–3 (Pb–Free)	
NCP803SN232T1G	2.32	140–460		SQR	SOT23–3 (Pb–Free)	
NCP803SN263T1G	2.63	140–460		SQC	SOT23–3 (Pb–Free)	
NCP803SN293T1G	2.93	140–460		SQD	SOT23–3 (Pb–Free)	
NCP803SN308T1G	3.08	140–460		SQE	SOT23–3 (Pb–Free)	
NCP803SN400T1G	4.00	140–460		RAD	SOT23–3 (Pb–Free)	
NCP803SN438T1G	4.38	140–460		SQF	SOT23–3 (Pb–Free)	- - - 3000 / Tape & Rea
NCP803SN463T1G	4.63	140–460		SQG	SOT23–3 (Pb–Free)	
NCP803SN120T1G	1.20	140–460		SSW	SOT23–3 (Pb–Free)	
NCP803SN293D1T1G	2.93	1–3.3		SSX	SOT23–3 (Pb–Free)	
NCP803SN293D2T1G	2.93	20–66	Open Drain RESET	SSY	SOT23–3 (Pb–Free)	
NCP803SN293D3T1G	2.93	100–330		SSZ	SOT23–3 (Pb–Free)	
MAX803SQ120T1G	1.20	140–460		ZV	SC70–3 (Pb–Free)	
MAX803SQ263T1G	2.63	140–460		SX	SC70–3 (Pb–Free)	
MAX803SQ293T1G	2.93	140–460		ZW	SC70–3 (Pb–Free)	
MAX803SQ308T1G	3.08	140–460	]	ZX	SC70–3	
NCV803SQ308T1G*		140–460		ZA	(Pb-Free)	
MAX803SQ438T1G	4.38	140–460		ZY	SC70–3 (Pb–Free)	
MAX803SQ463T1G	4.63	140–460		ZZ	SC70–3 (Pb–Free)	
MAX803SQ293D1T1G	2.93	1–3.3		YA	SC70–3 (Pb–Free)	
MAX803SQ293D2T1G	2.93	20–66		YB	SC70–3 (Pb–Free)	
MAX803SQ308D2T1G	3.08	20–66		SY	SC70-3	
NCV803SQ308D2T1G*		20–66		CY	(Pb-Free)	
MAX803SQ293D3T1G	2.93	100–330		YC	SC70–3 (Pb–Free)	
NCP803SN293T3G	2.93	140–460		SQD	SOT23–3 (Pb–Free)	10000 / Tape & Reel

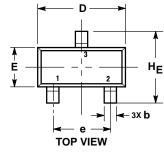
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

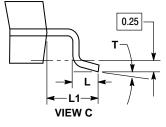
\*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable. \*\*Contact your ON Semiconductor sales representative for other threshold voltage options.

\*\*\*Contact your ON Semiconductor sales representative for timeout options availability for other threshold voltage options.

#### PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AR** 

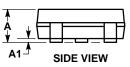


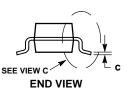




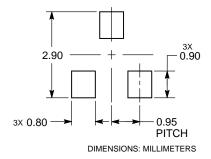
- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
  MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
  THE BASE MATERIAL.
  4. DIMENSIONS OF AND E DO NOT INCLUDE MOLD FLASH,
  PROTRUSIONS, OR GATE BURRS.

	м	ILLIMETE	RS	INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
Е	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
Т	0°		10°	0°		10°





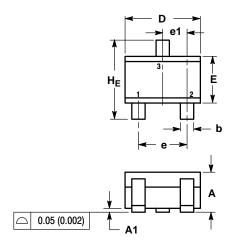
#### RECOMMENDED **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### PACKAGE DIMENSIONS

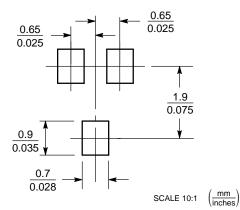
SC-70 (SOT-323) CASE 419-04 ISSUE N



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	м	ILLIMETE	RS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.90	1.00	0.032	0.035	0.040	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A2		0.70 REF			0.028 REF		
b	0.30	0.35	0.40	0.012	0.014	0.016	
С	0.10	0.18	0.25	0.004	0.007	0.010	
D	1.80	2.10	2.20	0.071	0.083	0.087	
Е	1.15	1.24	1.35	0.045	0.049	0.053	
e	1.20	1.30	1.40	0.047	0.051	0.055	
e1	0.65 BSC				0.026 BSC	;	
L	0.20	0.38	0.56	0.008	0.015	0.022	
HE	2.00	2.10	2.40	0.079	0.083	0.095	

SOLDERING FOOTPRINT\*



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and image are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor and applications using ON Semiconductor, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor reducts are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application. Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligient regarding the design or manufacture of the par

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

## ON Semiconductor:

NCP803SN160T1G NCP803SN232T1G NCP803SN263T1G NCP803SN293T1G NCP803SN293T3G NCP803SN308T1G NCP803SN438T1G NCP803SN463T1G MAX803SQ120T1G MAX803SQ293D1T1G MAX803SQ293D2T1G MAX803SQ293D3T1G MAX803SQ293T1G MAX803SQ308T1G MAX803SQ438T1G MAX803SQ463T1G NCP803SN120T1G NCP803SN293D1T1G NCP803SN293D2T1G NCP803SN293D3T1G NCP803SN400T1G NCV803SQ308T1G MAX803SQ308D2T1G MAX803SQ263T1G NCP803SN463D1T1G